

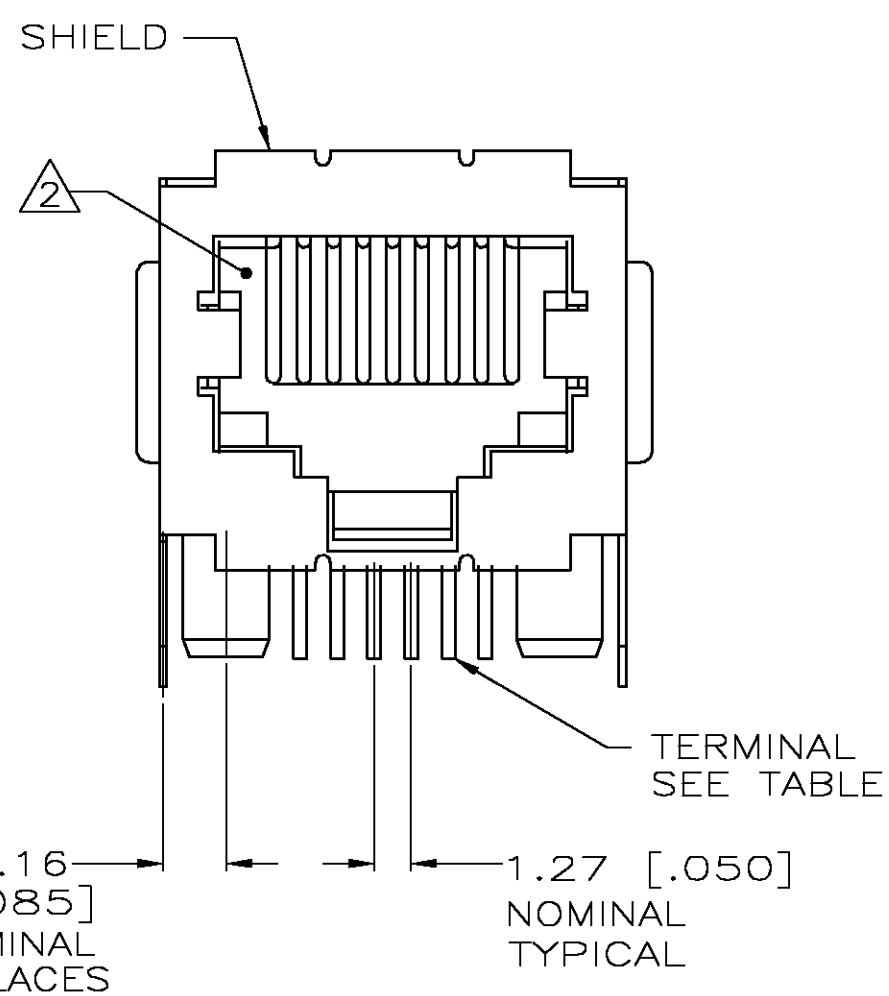
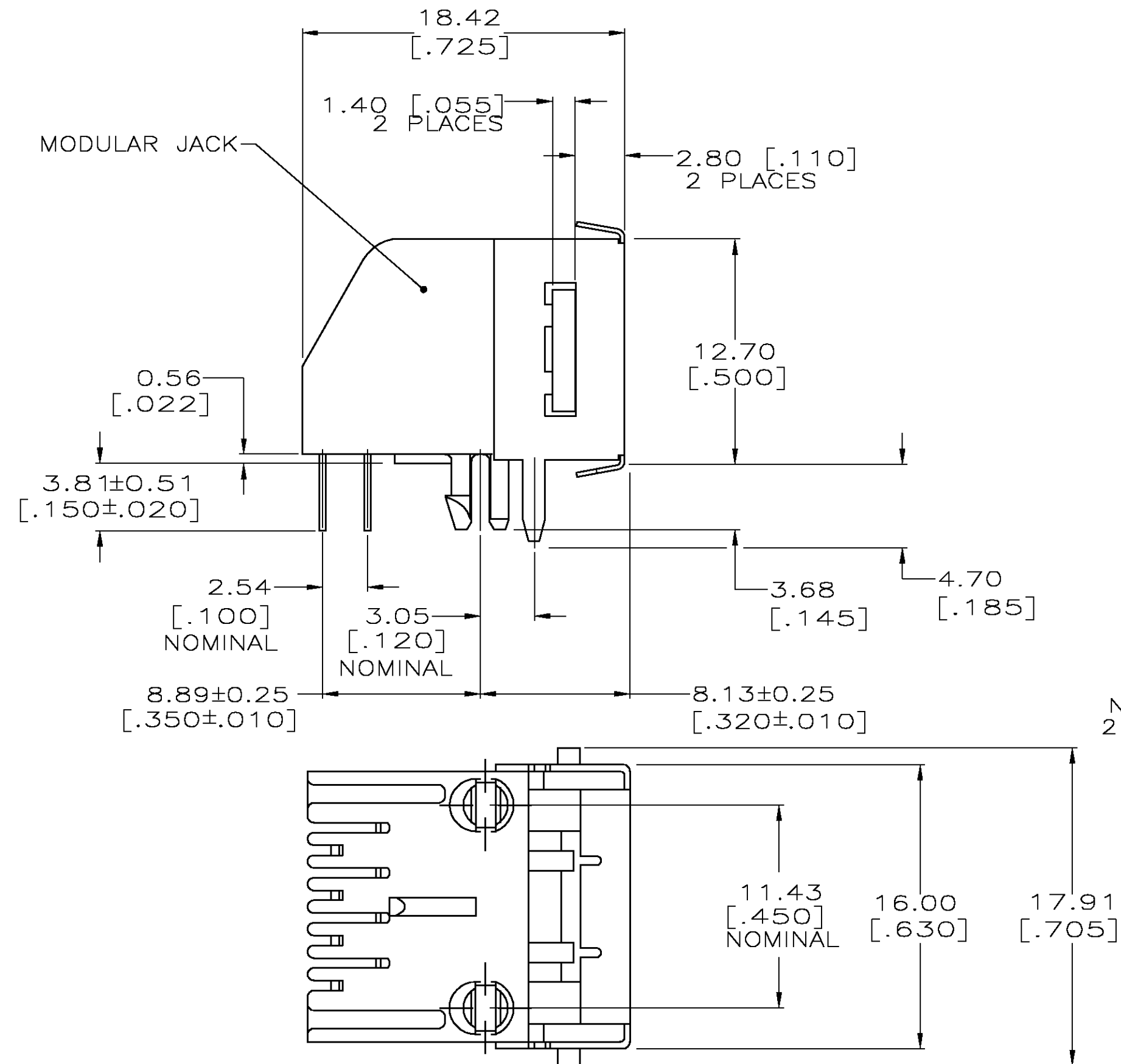
LOC	DIST	REVISIONS			
		P	LTR	DATE	DWN
AA	22	G		ADDED: -3 PER EC 0S11-0113-03	DD

D

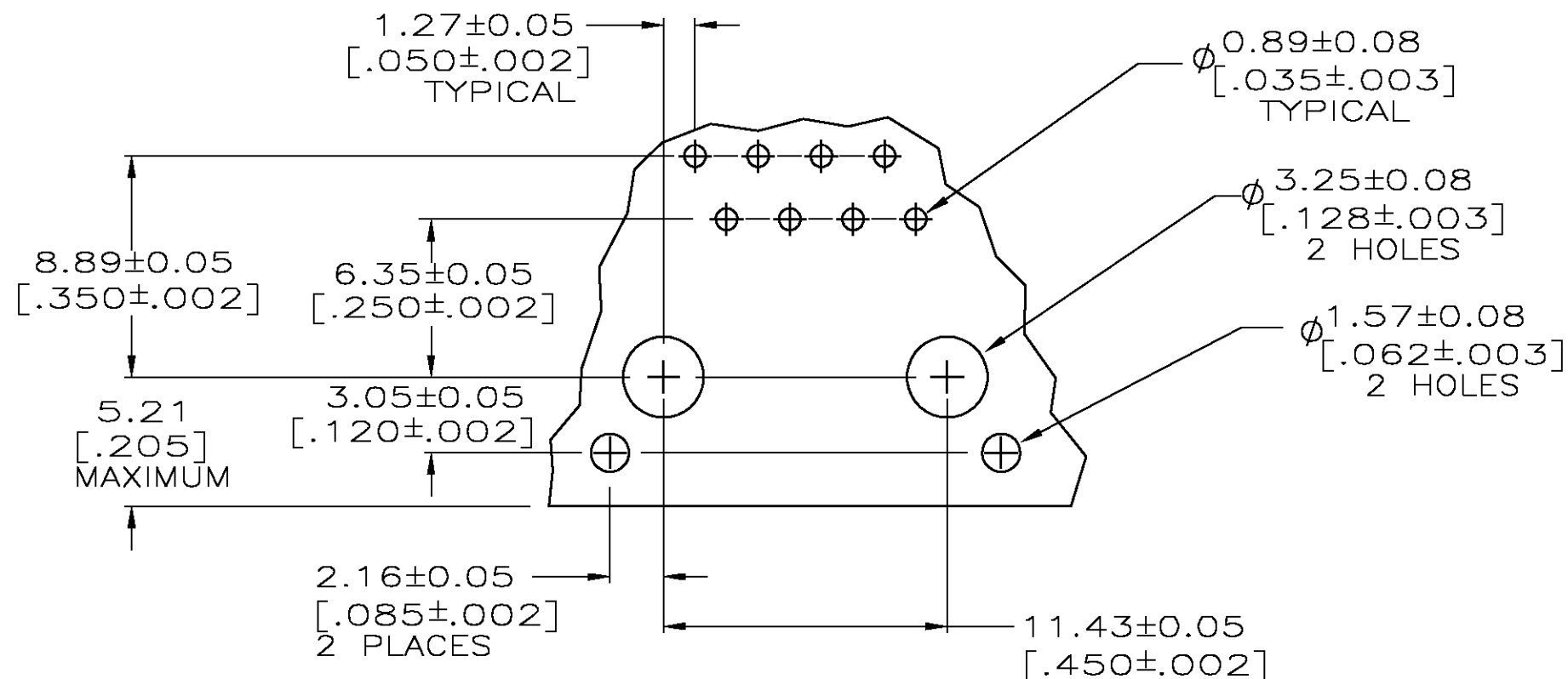
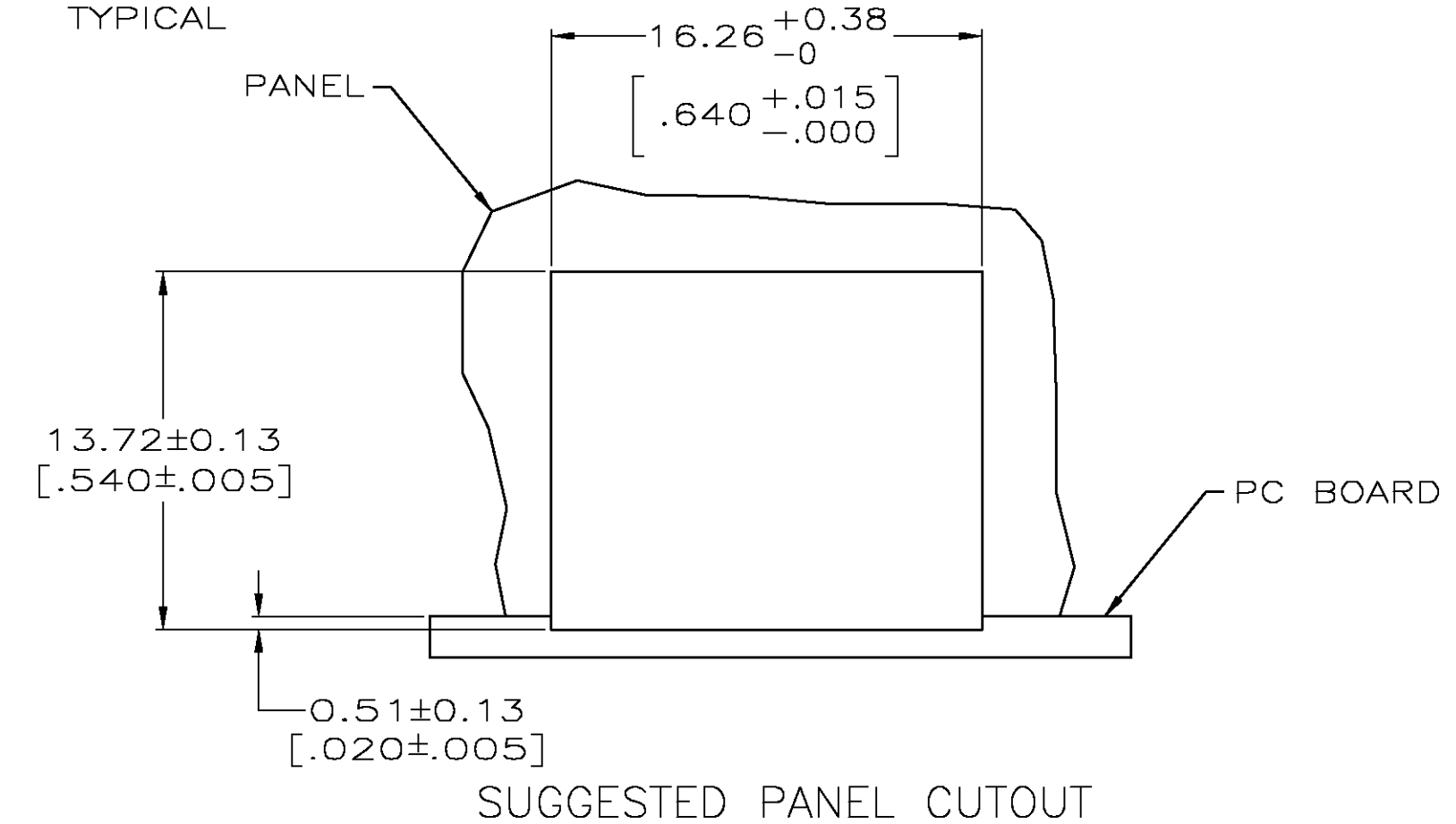
C

B

A



- 1 MATERIAL: HOUSING — PER TABLE, BLACK.
TERMINAL — 0.36 [.014] THICK PHOS-BRONZE PLATED WITH 1.27um [.000050] THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 3.81um [.000150] THICK TIN LEAD IN SOLDER AREA OVER 1.27um [.000050] THICK NICKEL UNDERPLATE
SHIELD — 0.25 [.010] THICK COPPER ALLOY, TIN-LEAD PLATED.
- 2 CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
3. ALL DIMENSIONS SHOWN ARE MAXIMUM UNLESS OTHERWISE SPECIFIED.



SUGGESTED PRINTED CIRCUIT BOARD MOUNTING HOLE LAYOUT
VIEW SHOWN AS CIRCUIT SIDE OF BOARD

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN G. GARRETT 7-10-95	tyco Electronics Tyco Electronics Corporation Harrisburg, PA 17105-3608			
		CHK N. JONES 8-25-95				
DIMENSIONS: MM [INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD J. TONEY 9-1-95	NAME			
	0 PLC ± - 1 PLC ± - 2 PLC ± - 3 PLC ± - 4 PLC ± - ANGLES ± ± - FINISH	PRODUCT SPEC 108-1163	MODULAR JACK ASSEMBLY, SHIELDED, 8 POSITION, LOW PROFILE, RIGHT ANGLE, PANEL GROUND WITH PANEL STOPS			
		APPLICATION SPEC 114-2048				
MATERIAL		WEIGHT -	SIZE A2	CAGE CODE 00779	DRAWING NO C-555141	RESTRICTED TO -
CUSTOMER DRAWING			SCALE 4:1	SHEET 1 OF 1	REV G	